

# MMUN2211LT1 Series

Preferred Devices

## Bias Resistor Transistor

### NPN Silicon Surface Mount Transistor with Monolithic Bias Resistor Network

This new series of digital transistors is designed to replace a single device and its external resistor bias network. The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space. The device is housed in the SOT-23 package which is designed for low power surface mount applications.

#### Features

- Simplifies Circuit Design
- Reduces Board Space and Component Count
- Pb-Free Packages are Available

#### MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	50	Vdc
Collector-Emitter Voltage	$V_{CEO}$	50	Vdc
Collector Current	$I_C$	100	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	246 (Note 1) 400 (Note 2) 1.5 (Note 1) 2.0 (Note 2)	mW $^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	508 (Note 1) 311 (Note 2)	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Lead	$R_{\theta JL}$	174 (Note 1) 208 (Note 2)	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

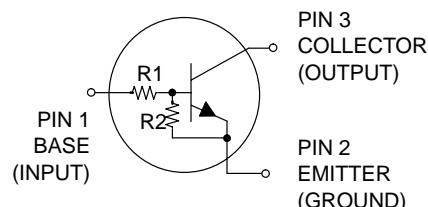
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-4 @ minimum pad
2. FR-4 @ 1.0 x 1.0 inch pad

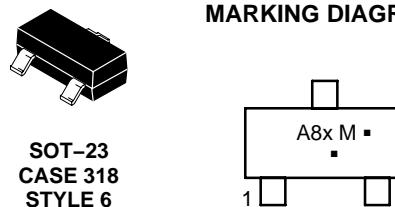


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#### MARKING DIAGRAM



A8x = Specific Device Code  
M = Date Code  
■ = Pb-Free Package  
(Note: Microdot may be in either location)

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

# MMUN2211LT1 Series

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Collector-Base Cutoff Current ( $V_{CB} = 50 \text{ V}$ , $I_E = 0$ )	$I_{CBO}$	—	—	100	nAdc
Collector-Emitter Cutoff Current ( $V_{CE} = 50 \text{ V}$ , $I_B = 0$ )	$I_{CEO}$	—	—	500	nAdc
Emitter-Base Cutoff Current ( $V_{EB} = 6.0 \text{ V}$ , $I_C = 0$ )	$I_{EBO}$	—	—	0.5	mAdc
MMUN2211LT1		—	—	0.2	
MMUN2212LT1		—	—	0.1	
MMUN2213LT1		—	—	0.2	
MMUN2214LT1		—	—	0.9	
MMUN2215LT1		—	—	1.9	
MMUN2216LT1		—	—	4.3	
MMUN2230LT1		—	—	2.3	
MMUN2231LT1		—	—	1.5	
MMUN2232LT1		—	—	0.18	
MMUN2233LT1		—	—	0.13	
MMUN2234LT1		—	—	4.0	
MMUN2238LT1		—	—	0.1	
MMUN2241LT1		—	—		
Collector-Base Breakdown Voltage ( $I_C = 10 \mu\text{A}$ , $I_E = 0$ )	$V_{(BR)CBO}$	50	—	—	Vdc
Collector-Emitter Breakdown Voltage (Note 3), ( $I_C = 2.0 \text{ mA}$ , $I_B = 0$ )	$V_{(BR)CEO}$	50	—	—	Vdc

**ON CHARACTERISTICS** (Note 3)

DC Current Gain ( $V_{CE} = 10 \text{ V}$ , $I_C = 5.0 \text{ mA}$ )	MMUN2211LT1 MMUN2212LT1 MMUN2213LT1 MMUN2214LT1 MMUN2215LT1 MMUN2216LT1 MMUN2230LT1 MMUN2231LT1 MMUN2232LT1 MMUN2233LT1 MMUN2234LT1 MMUN2238LT1 MMUN2241LT1	$h_{FE}$	35 60 80 80 160 160 3.0 8.0 15 80 80 160 160	60 100 140 140 350 350 5.0 15 30 200 150 350 350	— — — — — — — — — — — — —	
Collector-Emitter Saturation Voltage ( $I_C = 10 \text{ mA}$ , $I_B = 0.3 \text{ mA}$ ) ( $I_C = 10 \text{ mA}$ , $I_B = 5 \text{ mA}$ ) MMUN2230LT1/MMUN2231LT1 ( $I_C = 10 \text{ mA}$ , $I_B = 1 \text{ mA}$ ) MMUN2215LT1/MMUN2216LT1 MMUN2232LT1/MMUN2233LT1/MMUN2234LT1/ MMUN2238LT1	$V_{CE(sat)}$	—	—	0.25	Vdc	

3. Pulse Test: Pulse Width < 300  $\mu\text{s}$ , Duty Cycle < 2.0%.

# MMUN2211LT1 Series

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>ON CHARACTERISTICS</b> (Note 4)					
Output Voltage (on) ( $V_{CC} = 5.0 \text{ V}$ , $V_B = 2.5 \text{ V}$ , $R_L = 1.0 \text{ k } \Omega$ )  ( $V_{CC} = 5.0 \text{ V}$ , $V_B = 3.5 \text{ V}$ , $R_L = 1.0 \text{ k } \Omega$ )  ( $V_{CC} = 5.0 \text{ V}$ , $V_B = 5.0 \text{ V}$ , $R_L = 1.0 \text{ k } \Omega$ )	$V_{OL}$	—	—	0.2	Vdc
MMUN2211LT1 MMUN2212LT1 MMUN2214LT1 MMUN2215LT1 MMUN2216LT1 MMUN2230LT1 MMUN2231LT1 MMUN2232LT1 MMUN2233LT1 MMUN2234LT1 MMUN2238LT1  MMUN2213LT1 MMUN2241LT1		—	—	0.2	
Output Voltage (off) ( $V_{CC} = 5.0 \text{ V}$ , $V_B = 0.5 \text{ V}$ , $R_L = 1.0 \text{ k } \Omega$ ) ( $V_{CC} = 5.0 \text{ V}$ , $V_B = 0.050 \text{ V}$ , $R_L = 1.0 \text{ k } \Omega$ ) ( $V_{CC} = 5.0 \text{ V}$ , $V_B = 0.25 \text{ V}$ , $R_L = 1.0 \text{ k } \Omega$ )	$V_{OH}$	4.9	—	—	Vdc
MMUN2230LT1 MMUN2215LT1 MMUN2216LT1 MMUN2233LT1 MMUN2238LT1					
Input Resistor					
MMUN2211LT1 MMUN2212LT1 MMUN2213LT1 MMUN2214LT1 MMUN2215LT1 MMUN2216LT1 MMUN2230LT1 MMUN2231LT1 MMUN2232LT1 MMUN2233LT1 MMUN2234LT1 MMUN2238LT1 MMUN2241LT1	R1	7.0 15.4 32.9 7.0 7.0 3.3 0.7 1.5 3.3 3.3 15.4 1.54 70	10 22 47 10 10 4.7 1.0 2.2 4.7 4.7 22 2.2 100	13 28.6 61.1 13 13 6.1 1.3 2.9 6.1 6.1 28.6 2.88 130	k $\Omega$
Resistor Ratio	MMUN2211LT1/MMUN2212LT1/MMUN2213LT1 MMUN2214LT1 MMUN2215LT1/MMUN2216LT1/MMUN2238LT1 MMUN2241LT1 MMUN2230LT1/MMUN2231LT1/MMUN2232LT1 MMUN2233LT1 MMUN2234LT1	R1/R2	0.8 0.17 — — 0.8 0.055 0.38	1.0 0.21 — — 1.0 0.1 0.47	1.2 0.25 — — 1.2 0.185 0.56

4. Pulse Test: Pulse Width < 300  $\mu\text{s}$ , Duty Cycle < 2.0%.

# MMUN2211LT1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS MMUN2211LT1

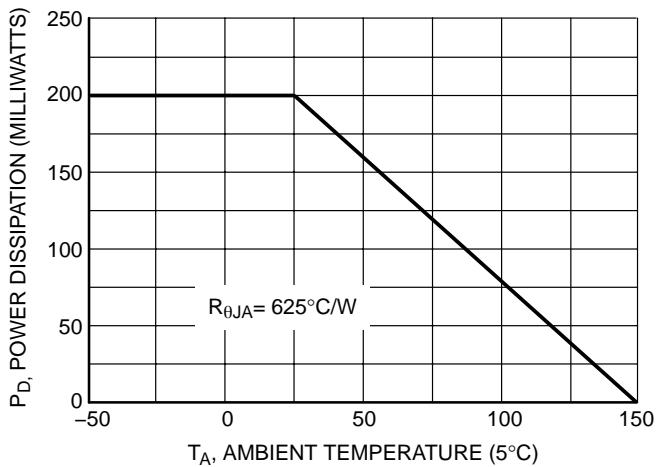


Figure 1. Derating Curve

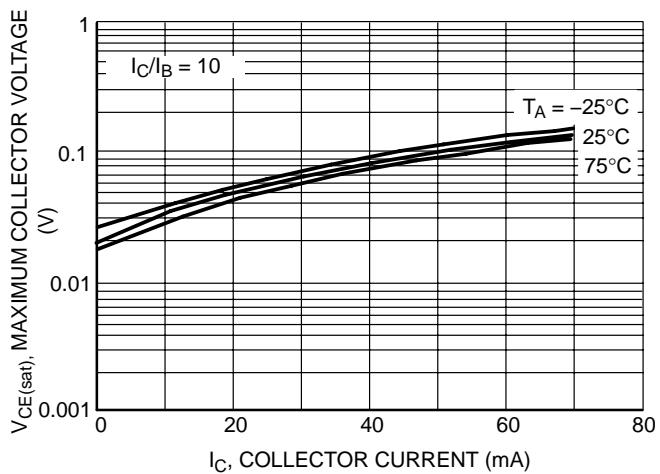


Figure 2.  $V_{CE(\text{sat})}$  vs.  $I_C$

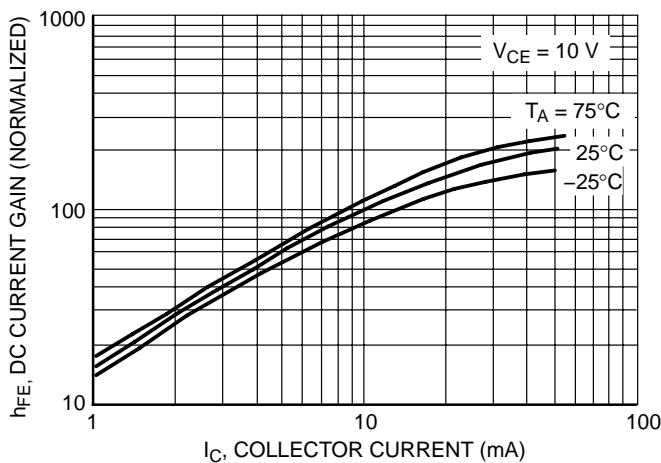


Figure 3. DC Current Gain

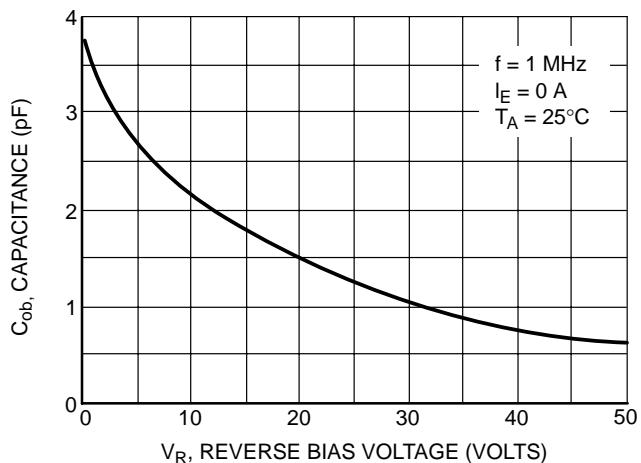


Figure 4. Output Capacitance

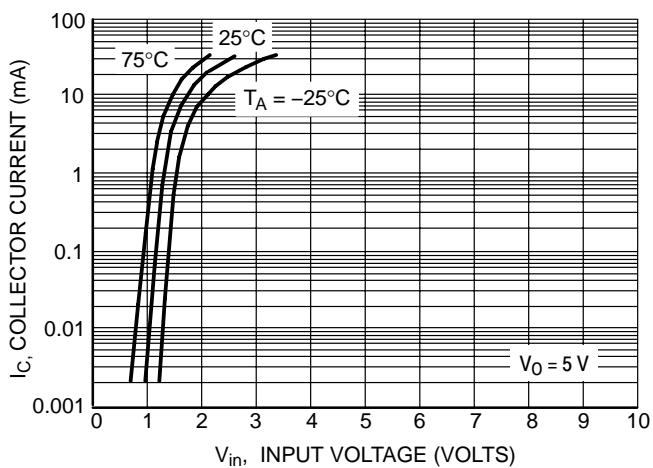


Figure 5. Output Current vs. Input Voltage

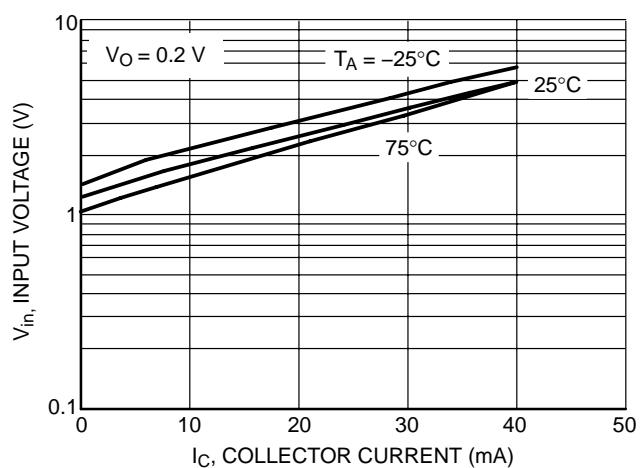


Figure 6. Input Voltage vs. Output Current

# MMUN2211LT1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS MMUN2212LT1

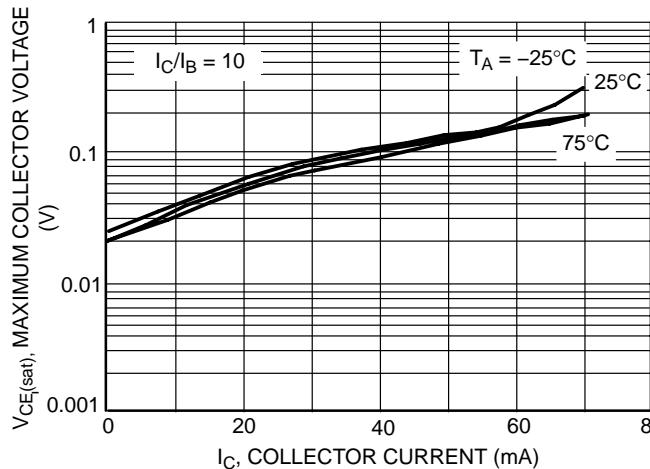


Figure 7.  $V_{CE(\text{sat})}$  vs.  $I_C$

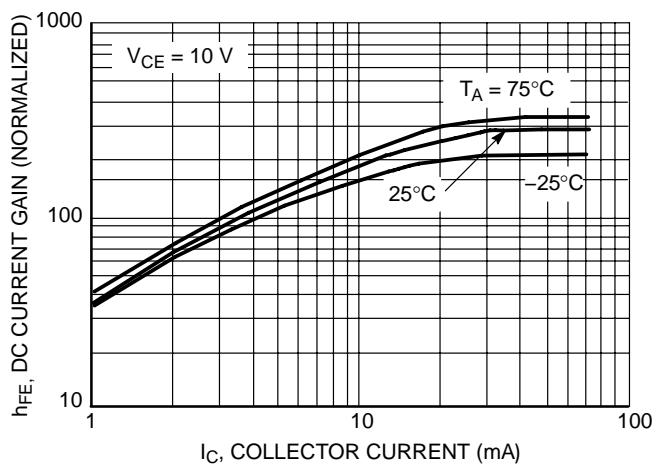


Figure 8. DC Current Gain

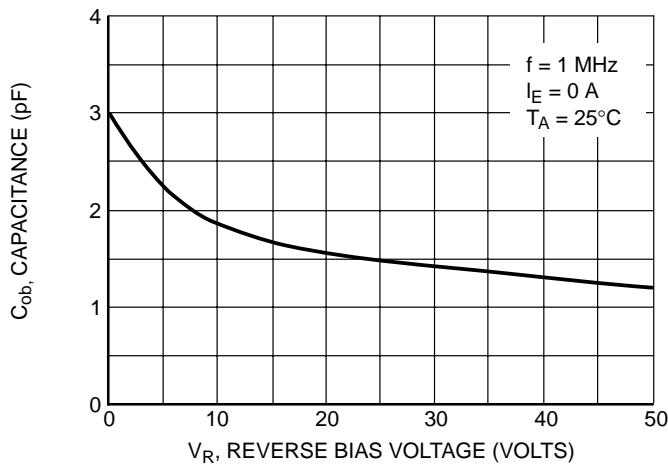


Figure 9. Output Capacitance

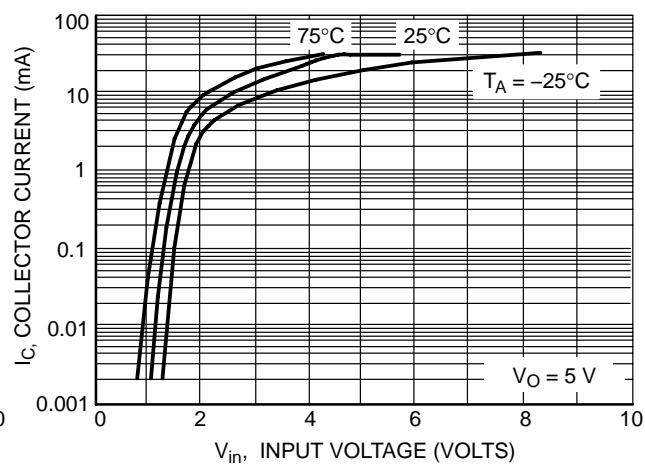


Figure 10. Output Current vs. Input Voltage

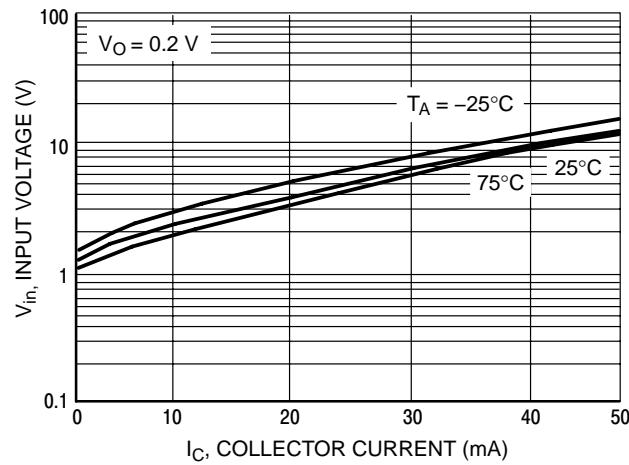
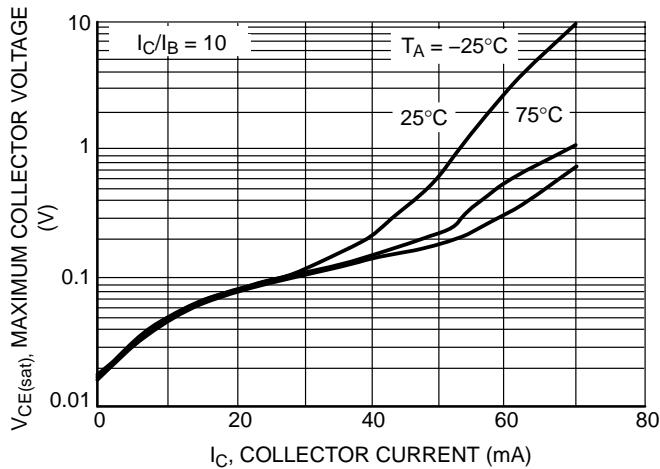


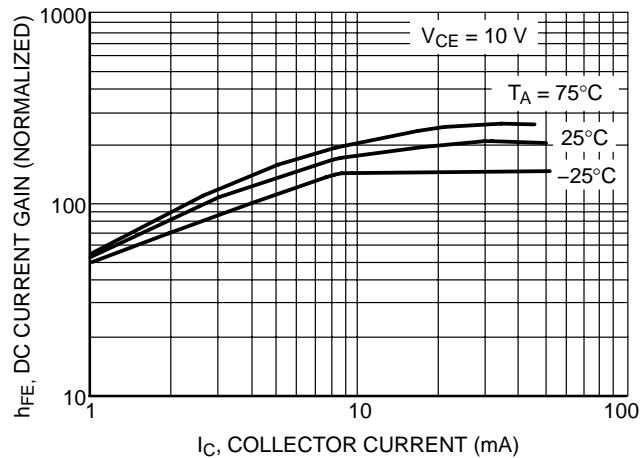
Figure 11. Input Voltage vs. Output Current

# MMUN2211LT1 Series

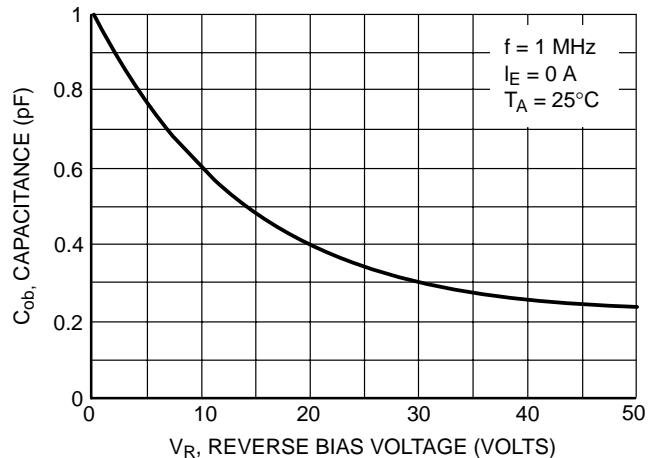
## TYPICAL ELECTRICAL CHARACTERISTICS MMUN2213LT1



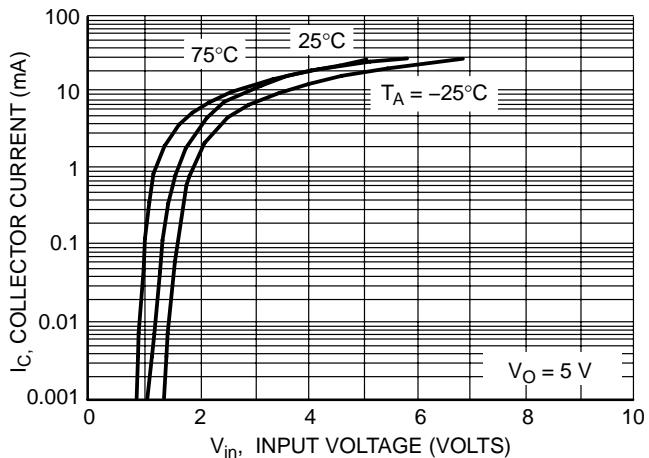
**Figure 12.  $V_{CE(sat)}$  vs.  $I_C$**



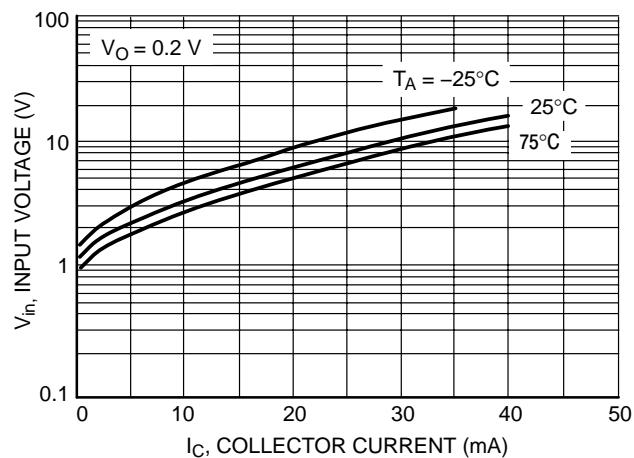
**Figure 13. DC Current Gain**



**Figure 14. Output Capacitance**



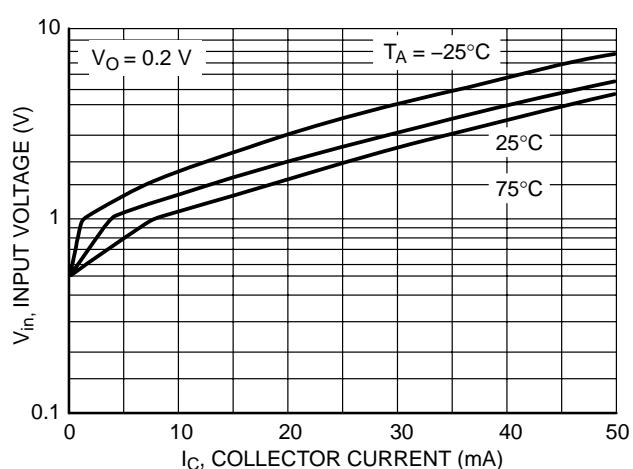
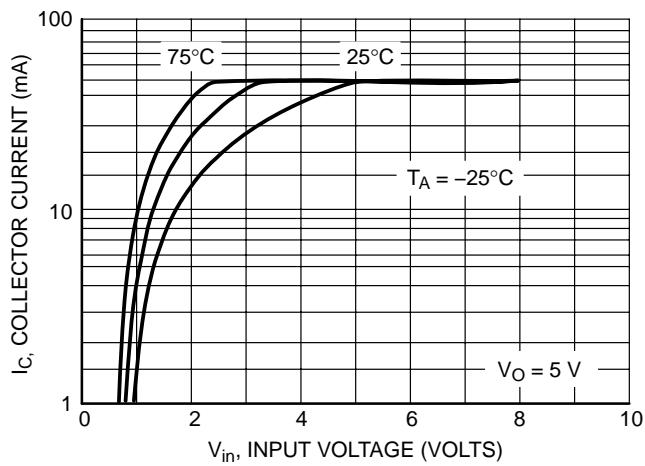
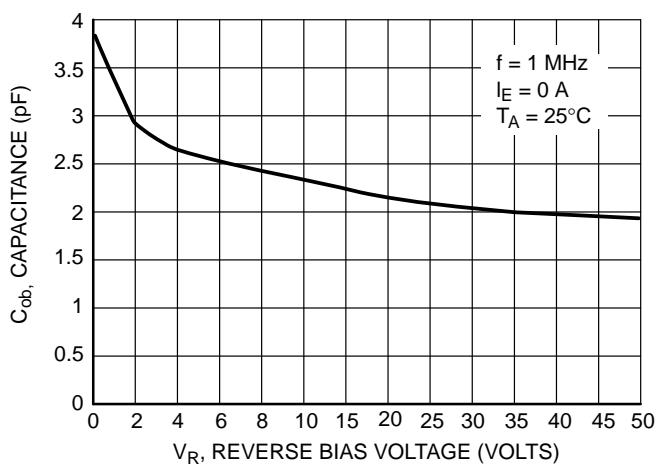
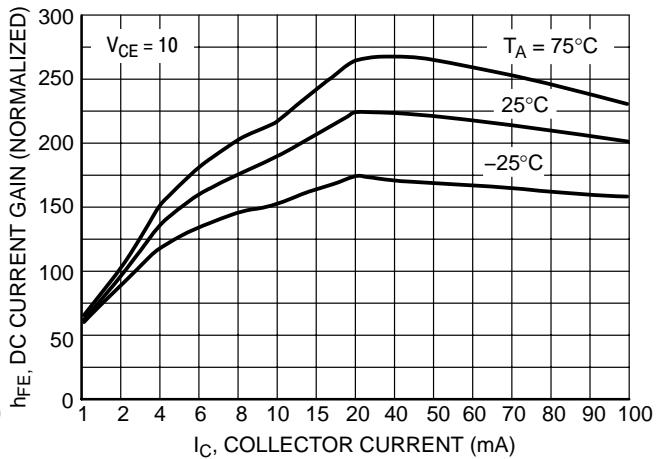
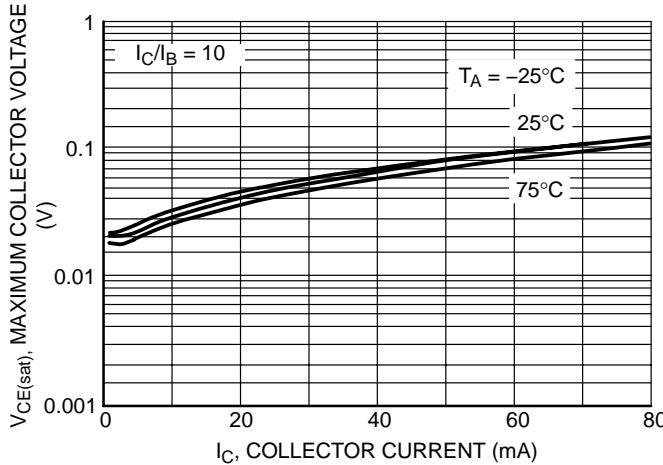
**Figure 15. Output Current vs. Input Voltage**



**Figure 16. Input Voltage vs. Output Current**

# MMUN2211LT1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS MMUN2214LT1



# MMUN2211LT1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS MMUN2232LT1

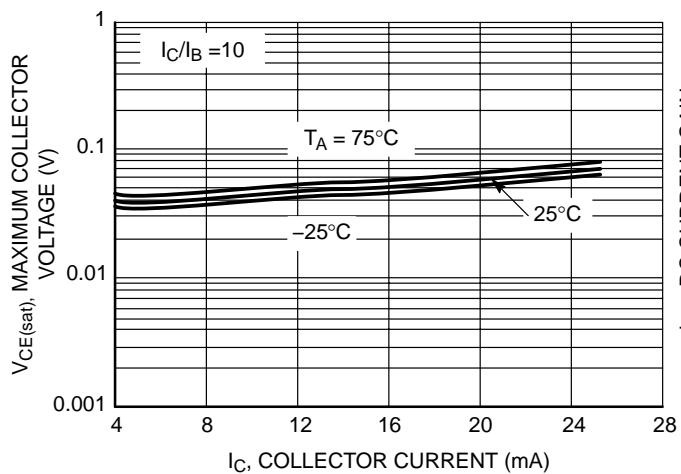


Figure 22.  $V_{CE(sat)}$  vs.  $I_C$

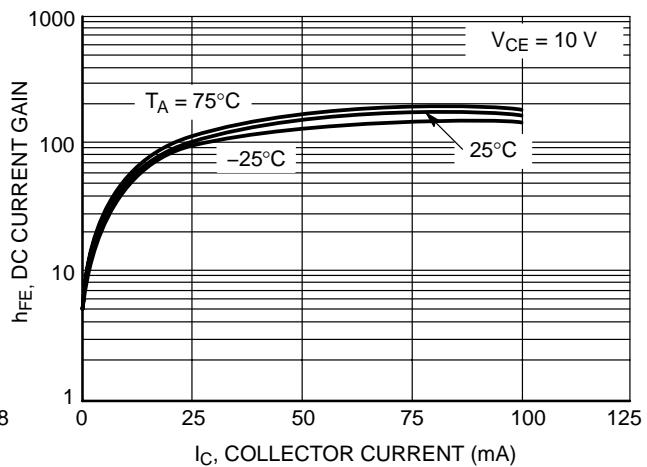


Figure 23. DC Current Gain

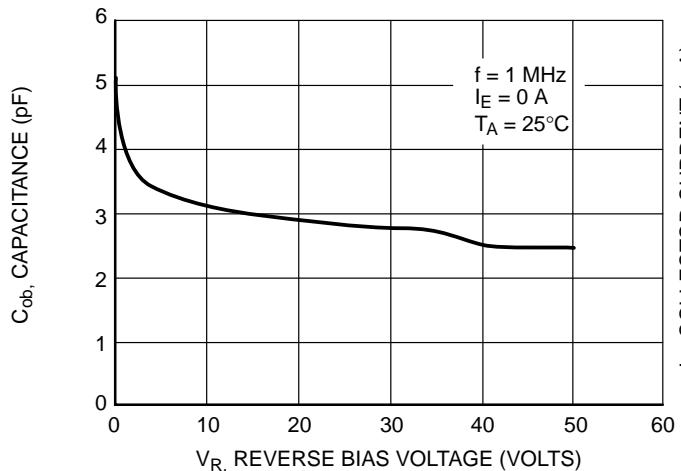


Figure 24. Output Capacitance

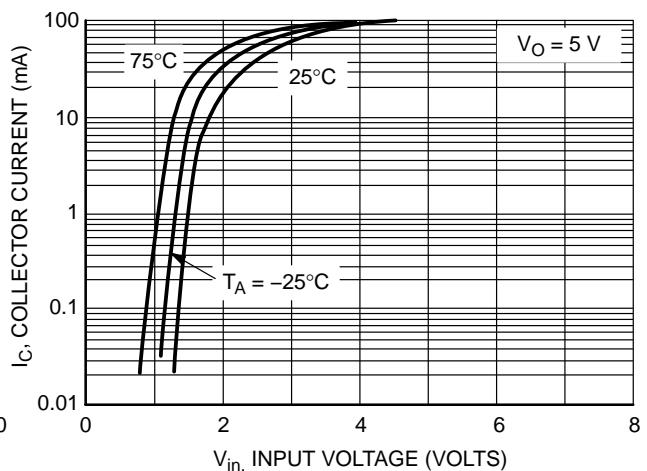


Figure 25. Output Current vs. Input Voltage

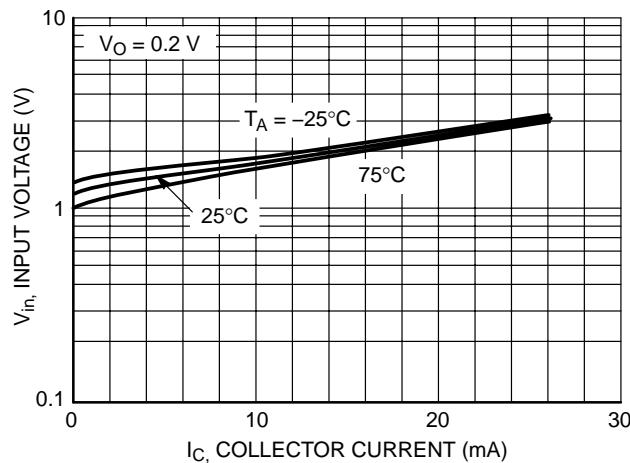
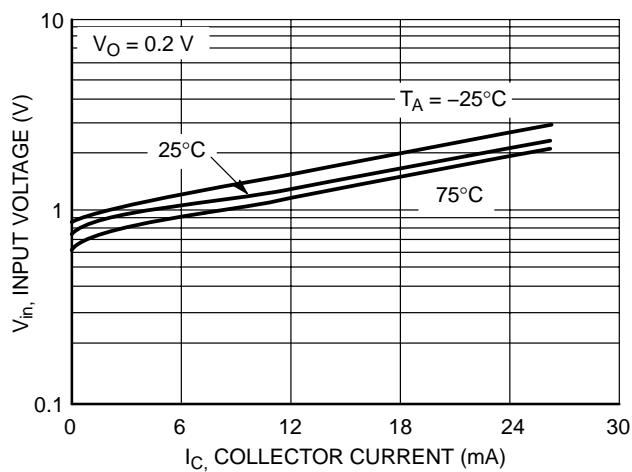
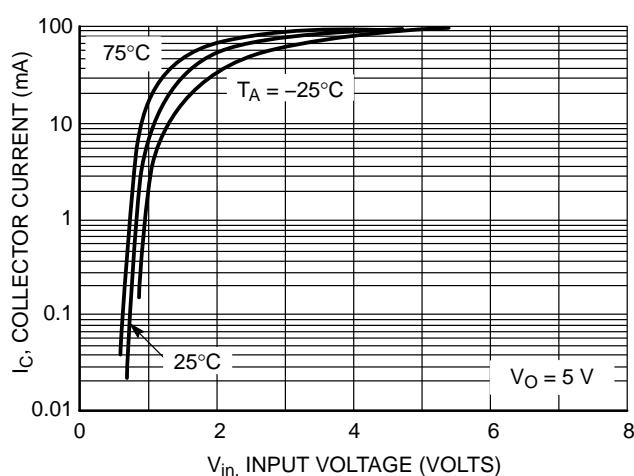
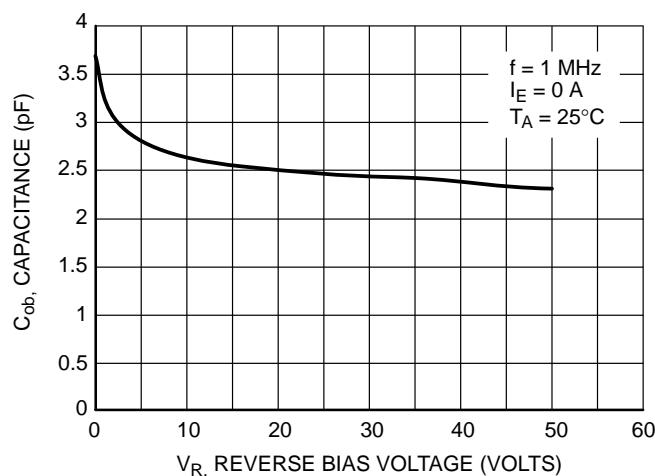
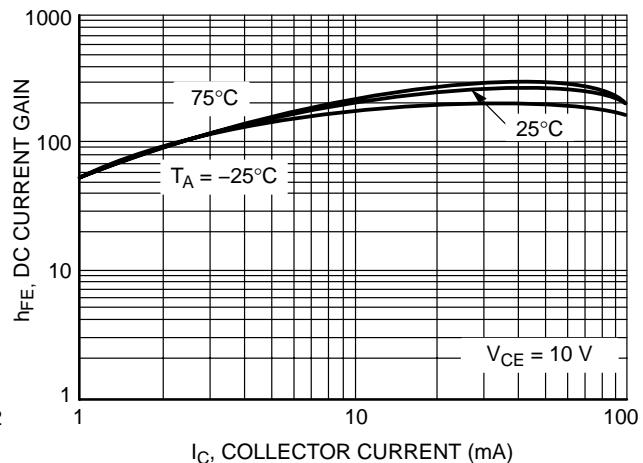
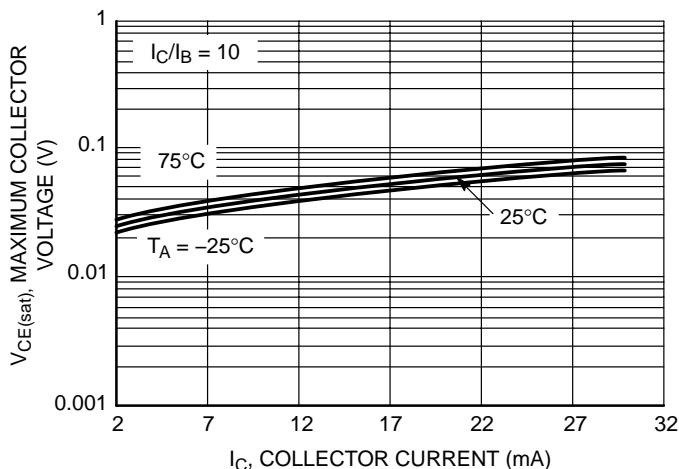


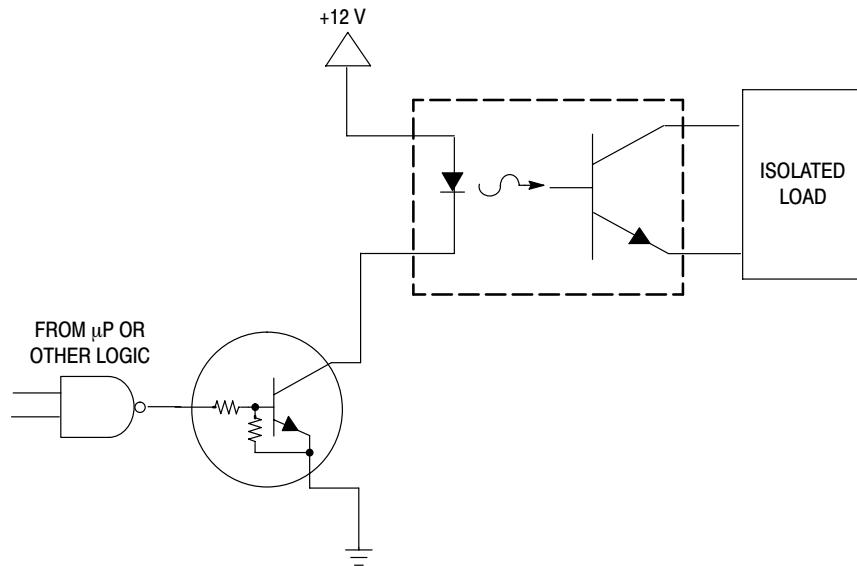
Figure 26. Output Voltage vs. Input Current

# MMUN2211LT1 Series

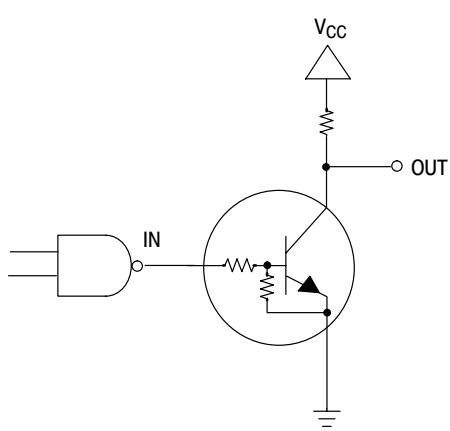
## TYPICAL ELECTRICAL CHARACTERISTICS MMUN2233LT1



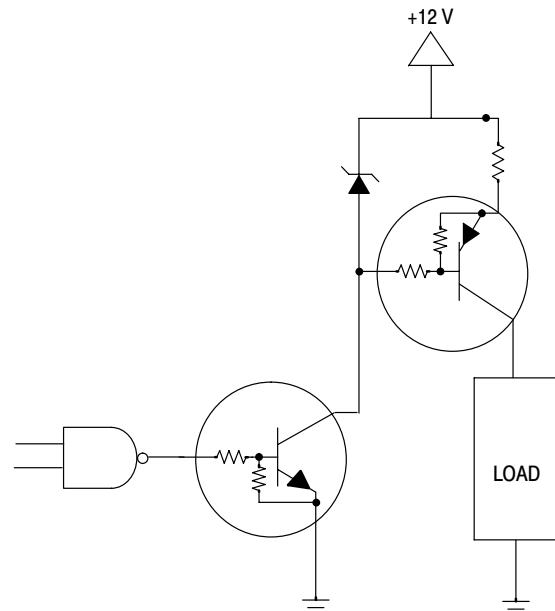
**TYPICAL APPLICATIONS FOR NPN BRTs**



**Figure 32. Level Shifter: Connects 12 or 24 Volt Circuits to Logic**



**Figure 33. Open Collector Inverter: Inverts the Input Signal**



**Figure 34. Inexpensive, Unregulated Current Source**

# MMUN2211LT1 Series

## ORDERING INFORMATION

Device	Marking	R1(k)	R2(k)	Package	Shipping <sup>†</sup>
MMUN2211LT1	A8A	10	10	SOT-23	3000 / Tape & Reel
MMUN2211LT1G		10	10	SOT-23 (Pb-Free)	
MMUN2211LT3		10	10	SOT-23	
MMUN2211LT3G		10	10	SOT-23 (Pb-Free)	
MMUN2212LT1	A8B	22	22	SOT-23	3000 / Tape & Reel
MMUN2212LT1G		22	22	SOT-23 (Pb-Free)	
MMUN2213LT1	A8C	47	47	SOT-23	
MMUN2213LT1G		47	47	SOT-23 (Pb-Free)	
MMUN2214LT1	A8D	10	47	SOT-23	
MMUN2214LT1G		10	47	SOT-23 (Pb-Free)	
MMUN2215LT1	A8E	10	∞	SOT-23	
MMUN2215LT1G		10	∞	SOT-23 (Pb-Free)	
MMUN2216LT1	A8F	4.7	∞	SOT-23	
MMUN2216LT1G		4.7	∞	SOT-23 (Pb-Free)	
MMUN2230LT1	A8G	1.0	1.0	SOT-23	3000 / Tape & Reel
MMUN2230LT1G		1.0	1.0	SOT-23 (Pb-Free)	
MMUN2231LT1	A8H	2.2	2.2	SOT-23	
MMUN2231LT1G		2.2	2.2	SOT-23 (Pb-Free)	
MMUN2232LT1	A8J	4.7	4.7	SOT-23	
MMUN2232LT1G		4.7	4.7	SOT-23 (Pb-Free)	
MMUN2233LT1	A8K	4.7	47	SOT-23	
MMUN2233LT1G		4.7	47	SOT-23 (Pb-Free)	
MMUN2234LT1	A8L	22	47	SOT-23	10,000 / Tape & Reel
MMUN2234LT1G		22	47	SOT-23 (Pb-Free)	
MMUN2234LT3		22	47	SOT-23	
MMUN2234LT3G		22	47	SOT-23 (Pb-Free)	
MMUN2238LT1	A8R	2.2	∞	SOT-23	3000 / Tape & Reel
MMUN2238LT1G		2.2	∞	SOT-23 (Pb-Free)	
MMUN2241LT1	A8U	100	∞	SOT-23	
MMUN2241LT1G		100	∞	SOT-23 (Pb-Free)	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

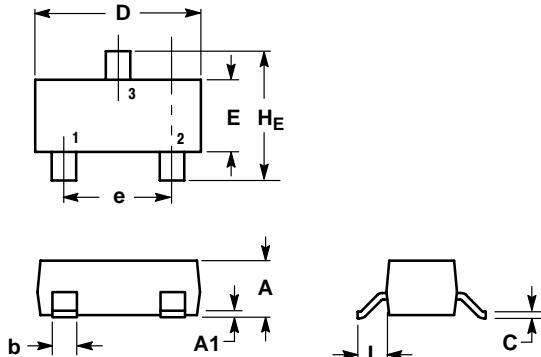
# MMUN2211LT1 Series

## PACKAGE DIMENSIONS

### SOT-23 (TO-236)

CASE 318-08

ISSUE AL



#### NOTES:

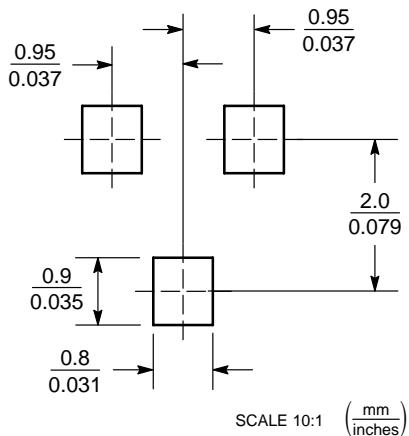
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
c	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.081
L	0.35	0.54	0.69	0.014	0.021	0.029
H_E	2.10	2.40	2.64	0.083	0.094	0.104

#### STYLE 6:

1. BASE
2. Emitter
3. Collector

## SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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